

SPECIFICATION

Customer Name						
Customer No.						
Product Description			0603 850nm Infrared LED			
Product Model			OR-HIR0603LF-CA-4T			
Orient Confirm			Customer Confirm			
Approved by	Checked by	Prepared by	Approved by	Quality	Engineering	
Linshixiu	Huanghaijun	Sushiheng				
Judge outcome:		ОК	Judge outcome:			









Add: Block A 3rd Floor No.4 Building Tian An Cyber Park Huang Ge Rd, Long Gang

1

Dist, Shenzhen, GD



OR-HIR0603LF-CA-4T

1. Features

- Small double-end package.
- High reliability.
- Low forward voltage.
- Peak wavelength λ p=850nm.
- Pb free.
- The product itself will remain within RoHS compliant version.

2. Applications

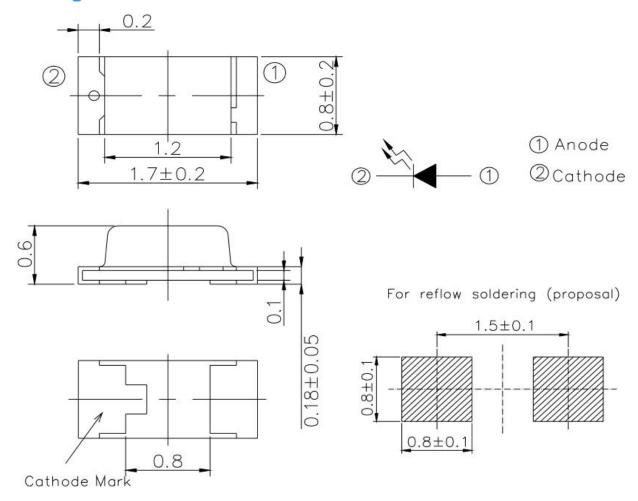
- PCB mounted infrared sensor.
- Optoelectronic switch.
- Smoke detector.
- Infrared applied system.

3. Device Selection Guide

LED Part No	Chip Material	Resin Color		
OR-HIR0603LF-CA-4T	GaAlAs	Water Clear		

OR-HIR0603LF-CA-4T

4. Package Outline Dimensions



Notes:

- 1). Tolerance is \pm 0.10mm unless otherwise specified.
- 2). Specifications are subject to change without notice.

5. Absolute maximum ratings at Ta=25℃

Parameter	Symbol	Rating	Unit	
Power Dissipation	P_{D}	130	mW	
Continuous Forward Current	I _F	65	mA	
Peak Forward Current	I _{FP}	1.0	Α	
Reverse Voltage	V_{R}	5	V	
Operating Temperature Range	T_{opr}	-40~+85	$^{\circ}$	
Storage Temperature Range	T_{stg}	-40~+100	$^{\circ}\!$	
Soldering Temperature	T_{sld}	Reflow Soldering:260°C ≤ 5 secs		

6、Electrical-optical characteristics at Ta=25℃

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Conversed Valters	M	I _F =20mA	-	1.45	1.65	- V
Forward Voltage	V _F	I _F =100mA	-	1.8	2.4	
Dedicat Interest.	1	I _F =20mA	0.2	0.8	-	-mW/sr
Radiant Intensity	l _e	I _F =100mA	-	4.2	-	
Reverse Current	I_R	V _R =5V	-	-	10	uA
Peak Wave Length	λ_{P}	I _F =20mA	-	850	-	nm
Spectral Line Half-width	Δλ	I _F =50mA	-	45	-	nm
Viewing Angle	2θ _{1/2}	I _F =20mA	-	145	-	deg

Notes:

- 1. Tolerance of radiant intensity is $\pm 10\%$.
- 2. Tolerance of forward voltage is ±0.1V.



OR-HIR0603LF-CA-4T

7. Typical optical characteristics curves

Fig.1 Forward Current vs.

Ambient Temperature

140 120 100 Forward Current (mA) 80 60 40 20 0 40 60 80 -25 0 20 100 Ambient Temperature (°C)

Fig.2 Spectral Distribution

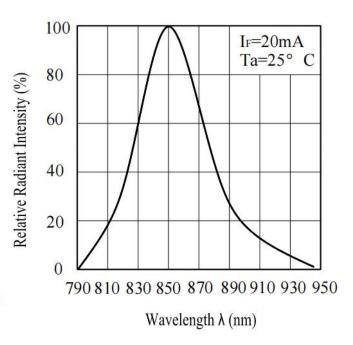


Fig.3 Peak Emission Wavelength
Ambient Temperature

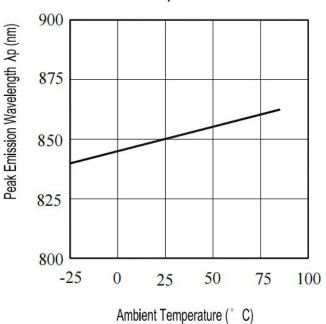


Fig.4 Forward Current vs. Forward Voltage

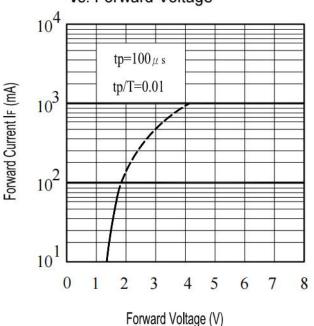




Fig.5 Relative Intensity vs.

Forward Current

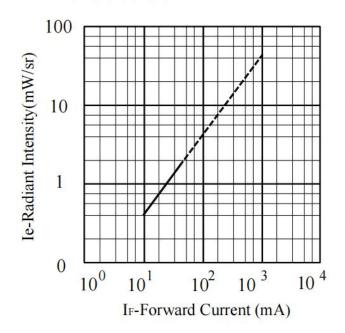


Fig.7 Relative Intensity vs.

Ambient Temperature(°C)

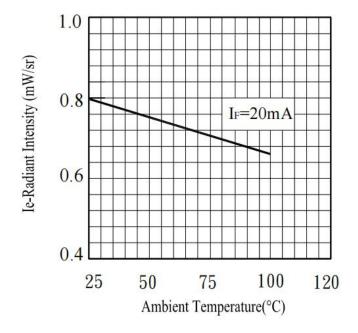


Fig.6 Relative Radiant Intensity vs.

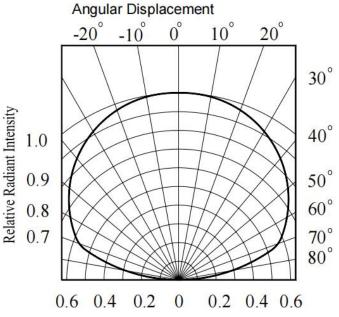
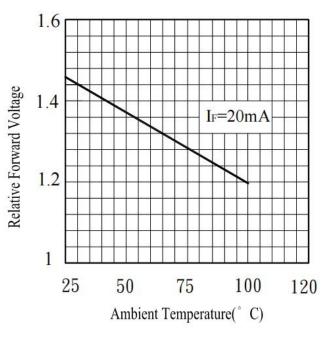


Fig.8 Forward Voltage vs.

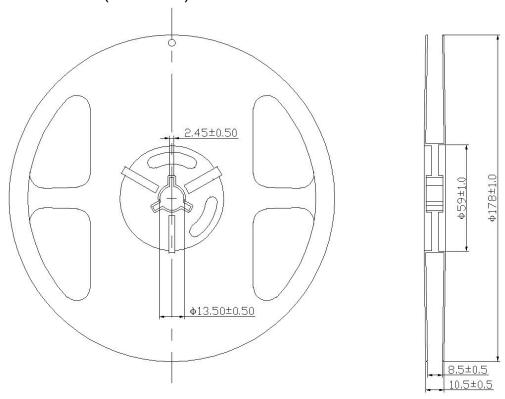
Ambient Temperature(°C)



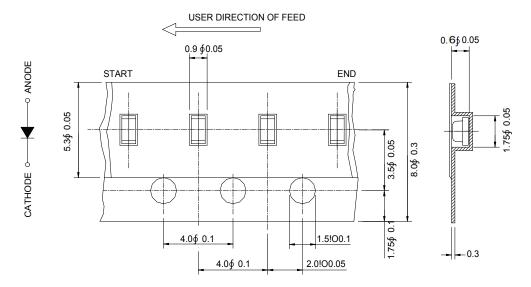
OR-HIR0603LF-CA-4T

8. Packaging Specification

•Dimensions for Reel (Unit: mm)



•Dimensions of Tape (Unit: mm)



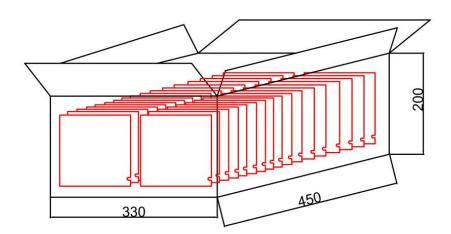
Notes:

- 1. All dimensions are in mm, tolerance is±0.1mm unless otherwise noted.6
- 2. Specifications are subject to change without notice.
- 3. Loaded quantity: 4000 pcs/reel.

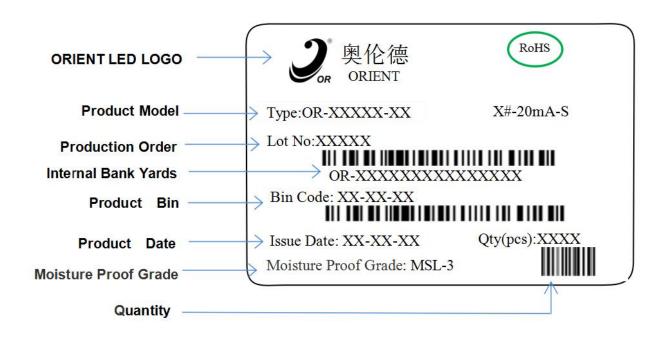


OR-HIR0603LF-CA-4T

◆Package Method: Vacuum (Unit: mm)



9. Label description

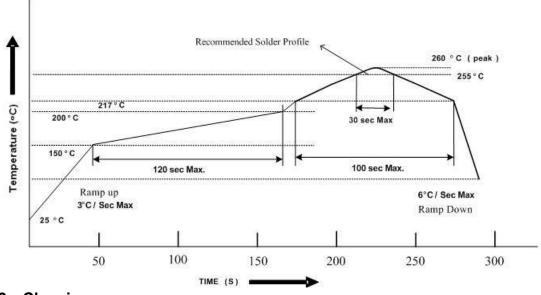


10. Precautions for use

1. Soldering

SMD LED encapsulation is very flexible, outside force easily demolish radiant surface and plastic, As soldering, Please handle with care!

- 1.1. With No-clean Flux, according to reflow soldering cure condition when soldering, Reflow soldering should not be done more than two times, simultaneity you must insure clean on the radiant surface. Otherwise, foreign objects can affect radiant color.
- 1.2. Don't process manual soldering except repair. Recommended to be soldered with 25W Anti-static iron, The temp. of the iron should be lower than $300^{\circ}C$ and soldering time should not be done more than three seconds, at the same time iron can't touch radiant surface and plastic.
- 1.3. Don't twist LED in course of manual soldering and experiment, otherwise, the lights will not work possibly.
- 1.4. Please use the same BIN grade in one panel, and don't mix the difference BIN grade in one panel when soldering. Otherwise, it will cause a serious uneven color problem.
- 1.5. Please control the sulfur content of solder paste and PCB.
- 1.6. Pb-free solder temp.-time profile as below:260 °C Max



2、Cleaning

- 2.1. Don't be cleaned with ultrasonic. Recommended to be wiped with isopropyl alcohol or pure alcohol, wiping time should not be more than one minute. LED must be placed at room temperature for fifteen minutes before using. After cleaning, you must insure clean on the radiant surface. Otherwise, foreign objects can affect radiant color.
- 2.2. LED can not be in contact with isoamyl acetate, trichloroethylene, acetone, sulfide, nitride, acid, alkali, salt. These matter can destroy LED.

3. Sealing

- 3.1. Sealing glue can not contain sodium ion, sulfide, because these matter can affect fluorescence powder poisoning.
- 3.2. When using normal sealing glue, Use within 168 hours after opening



4. Storage

- 4.1. Don't open the moisture proof bag before ready to use the LEDs.
- 4.2. The LEDs should be kept at 30°C or less and 60%RH or less before opening the package. The max. storage period before opening the package is 1 year.
- 4.3. After opening the package, the LEDs should be kept at 30-35%RH or less, and it should be used within 3 days. If the LEDs should be kept at 30-35%RH or more, and it should be used within 4 hours.
- 4.4. If the LEDs be kept over the conditions of 20%, baking is required before mounting. Baking condition as below: 70±5℃ for 12 hrs for bulk goods, 105±5℃ for 1 hrs for roll goods.
- 4.5. The environment have no acid, alkali, corrosive gas, intensively shake and high magnetic field.

5 Static

- 5.1. Static and Peak surge voltage can destroy LED, Avoiding Instantaneous voltage when turn on or turn off the lights.
- 5.2. Please wear Anti-static wrist band, Anti-static glove, Anti-static shoes in the course of operation, and the equipment must be grounded.

6、Test

- 6.1. Customer must apply the current limiting resistor in the circuit so as to drive the LEDs within the rated current. Otherwise slight voltage shift maybe will cause big current change and burn out will happen.
- 6.2. Also, caution should be taken not to overload the LEDs with instantaneous high voltage at the turning ON and OFF of the circuit. Otherwise, The LEDs will be destroyed, testing methods as follows:
- 6.3. The reverse voltage mustn't exceed 5v when lighting on or testing the LED, otherwise, The LEDs will be damaged.

7、Else

Radiant color of LEDs have a little change with the current, recommended that LED is used in series and resistance, when lighting, please don't see directly radiant surface of LED, otherwise LED will burn eyes.